BYG21K-M3/HM3, BYG21M-M3/HM3

Vishay General Semiconductor

COMPLIANT

HALOGEN

FREE

Fast Avalanche SMD Rectifier



DO-214AC (SMA)

PRIMARY CHARACTERISTICS				
I _{F(AV)}	1.5 A			
V_{RRM}	800 V, 1000 V			
I _{FSM}	30 A			
I _R	1.0 μΑ			
V_{F}	1.6 V			
t _{rr}	120 ns			
E _R	20 mJ			
T _J max.	150 °C			
Package	DO-214AC (SMA)			
Diode variation Single die				

FEATURES

- Low profile package
- · Ideal for automated placement
- · Glass passivated pellet chip junction
- Low reverse current
- · Soft recovery characteristic
- Fast reverse recovery time
- Meets MSL level 1, per J-STD-020, LF maximum peak of 260 °C
- AEC-Q101 qualified
- Material categorization: for definitions of compliance please see <u>www.vishav.com/doc?99912</u>

TYPICAL APPLICATIONS

For use in fast switching rectification of power supply, inverters, converters, and freewheeling diodes for consumer, automotive, and telecommunication.

MECHANICAL DATA

Case: DO-214AC (SMA)

Molding compound meets UL 94 V-0 flammability rating Base P/N-M3 - halogen-free, RoHS-compliant, and commercial grade

Base P/NHM3 - halogen-free, RoHS-compliant, and AEC-Q101 qualified

Terminals: Matte tin plated leads, solderable per J-STD-002 and JESD 22-B102

M3 suffix meets JESD 201 class 2 whisker test, HM3 suffix meets JESD 201 class 2 whisker test

Polarity: Color band denotes the cathode end

MAXIMUM RATINGS (T _A = 25 °C unless otherwise noted)					
PARAMETER	SYMBOL	BYG21K	BYG21M	UNIT	
Device marking code		BYG21K	BYG21M		
Maximum repetitive peak reverse voltage	V _{RRM}	800	1000	V	
Average forward current	I _{F(AV)}	1.5		Α	
Peak forward surge current 10 ms single half sine-wave superimposed on rated load	I _{FSM}	30		А	
Pulse energy in avalanche mode, non repetitive (inductive load switch off) $I_{(BR)R} = 1$ A, $T_J = 25$ °C	E _R	20		mJ	
Operating junction and storage temperature range	T _J , T _{STG}	-55 to +150		°C	

BYG21K-M3/HM3, BYG21M-M3/HM3

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ELECTRICAL CHARACTERISTICS (T _A = 25 °C unless otherwise noted)						
PARAMETER	TEST CONDITIONS		SYMBOL	BYG21K	BYG21M	UNIT
Maximum instantaneous	I _F = 1 A	- T _J = 25 °C	V _E (1)	1.	5	V
forward voltage	I _F = 1.5 A		v _F (.,)	1.	6	v
Maximum reverse current		T _J = 25 °C	I _R -	1		
	$V_R = V_{RRM}$	T _J = 100 °C		10		μA
Maximum reverse recovery time	I _F = 0.5 A, I _R = 1.0 A, I _{rr} = 0.25 A		t _{rr}	120		ns

Note

 $^{(1)}$ Pulse test: 300 μs pulse width, 1 % duty cycle

THERMAL CHARACTERISTICS (T _A = 25 °C unless otherwise noted)				
PARAMETER	SYMBOL	BYG21K	BYG21M	UNIT
Typical thermal resistance, junction to lead, T _L = const.	$R_{\theta JL}$	25		°C/W
Typical thermal resistance, junction to ambient	R _{θJA} ⁽¹⁾	150		
	R _{θJA} ⁽²⁾	125		°C/W
	R ₀ JA (3)	10	00	

Notes

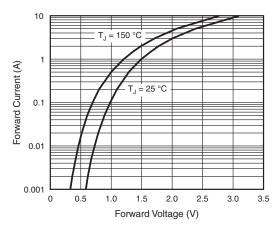
- (1) Mounted on epoxy-glass hard tissue
- $^{(2)}$ Mounted on epoxy-glass hard tissue, 50 mm 2 35 μ m Cu
- (3) Mounted on Al-oxide-ceramic (Al₂O₃), 50 mm² 35 μm Cu

ORDERING INFORMATION (Example)					
PREFERRED P/N	UNIT WEIGHT (g)	PREFERRED PACKAGE CODE	BASE QUANTITY	DELIVERY MODE	
BYG21K-M3/TR	0.064	TR	1800	7" diameter plastic tape and reel	
BYG21K-M3/TR3	0.064	TR3	7500	13" diameter plastic tape and reel	
BYG21KHM3/TR (1)	0.064	TR	1800	7" diameter plastic tape and reel	
BYG21KHM3/TR3 (1)	0.064	TR3	7500	13" diameter plastic tape and reel	

Note

(1) AEC-Q101 qualified

RATINGS AND CHARACTERISTICS CURVES (T_A = 25 °C unless otherwise noted)





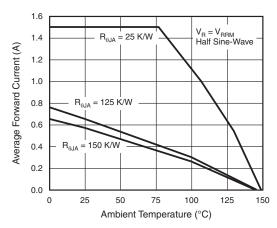


Fig. 2 - Max. Average Forward Current vs. Ambient Temperature





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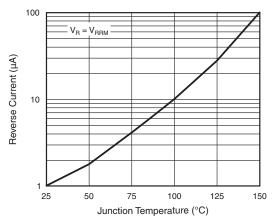


Fig. 3 - Reverse Current vs. Junction Temperature

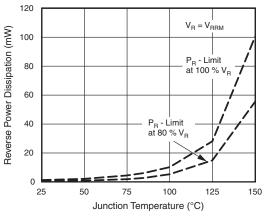


Fig. 4 - Max. Reverse Power Dissipation vs. Junction Temperature

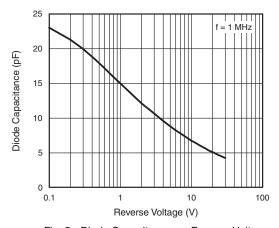


Fig. 5 - Diode Capacitance vs. Reverse Voltage

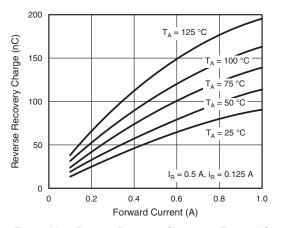


Fig. 6 - Max. Reverse Recovery Charge vs. Forward Current

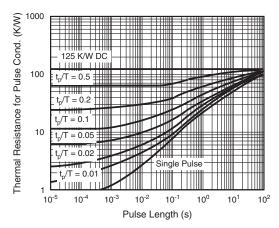


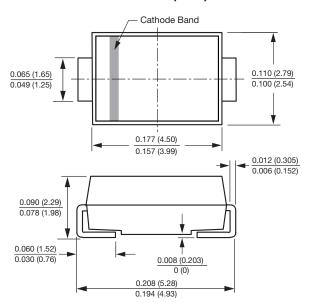
Fig. 7 - Thermal Response

BYG21K-M3/HM3, BYG21M-M3/HM3

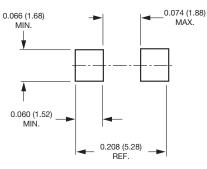
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PACKAGE OUTLINE DIMENSIONS in inches (millimeters)

DO-214AC (SMA)



Mounting Pad Layout





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